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DATE MAILED: 01/24/2005

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/657,875	09/09/2003	Chien-Ming Cheng	LELI 3495	2089
321	7590 01/24/2005		EXAMINER	
SENNIGER POWERS LEAVITT AND ROEDEL			IM, JUNGHWA M	
ONE METRO 16TH FLOO	OPOLITAN SQUARE R		ART UNIT	PAPER NUMBER
ST LOUIS,			2811	

Please find below and/or attached an Office communication concerning this application or proceeding.

		An.	,
	Application No.	Applicant(s)	
	10/657,875	CHENG ET AL.	
Office Action Summary	Examiner	Art Unit	
	Junghwa M. Im	2811	
The MAILING DATE of this communication a		ith the correspondence address	
Period for Reply		IONELIKO) EDOM	
A SHORTENED STATUTORY PERIOD FOR REP THE MAILING DATE OF THIS COMMUNICATION  - Extensions of time may be available under the provisions of 37 CFR 1 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a re If NO period for reply is specified above, the maximum statutory perio  - Failure to reply within the set or extended period for reply will, by statu. Any reply received by the Office later than three months after the mail earned patent term adjustment. See 37 CFR 1.704(b).	I.  1.136(a). In no event, however, may a sply within the statutory minimum of thin d will apply and will expire SIX (6) MOI ate, cause the application to become Al	reply be timely filed  ty (30) days will be considered timely.  NTHS from the mailing date of this communication.  BANDONED (35 U.S.C. § 133).	
Status	į.		
1) Responsive to communication(s) filed on 29	September 2004.		
2a)⊠ This action is <b>FINAL</b> . 2b)☐ Th	is action is non-final.		
3) Since this application is in condition for allow	·	• •	
closed in accordance with the practice under	Ex parte Quayle, 1935 C.E	). 11, 453 O.G. 213.	
Disposition of Claims			
4)⊠ Claim(s) <u>1-8</u> is/are pending in the application	l.		
4a) Of the above claim(s) is/are withdr	awn from consideration.		
5) Claim(s) is/are allowed.			
6)⊠ Claim(s) <u>1-8</u> is/are rejected.			
7) Claim(s) is/are objected to.			
8) Claim(s) are subject to restriction and	or election requirement.		
Application Papers			
9)☐ The specification is objected to by the Examir	ner.		
10) ☐ The drawing(s) filed on is/are: a) ☐ ac	ccepted or b) objected to	by the Examiner.	
Applicant may not request that any objection to th		` '	
Replacement drawing sheet(s) including the corre	,	, , , ,	
11) ☐ The oath or declaration is objected to by the B	Examiner. Note the attache	d Office Action or form PTO-152.	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of:  1. Certified copies of the priority documents.  2. Certified copies of the priority documents.  3. Copies of the certified copies of the prince application from the International Bure.  * See the attached detailed Office action for a list	nts have been received. nts have been received in A lority documents have been au (PCT Rule 17.2(a)).	Application No  received in this National Stage	
Attachment(s)			
1) Notice of References Cited (PTO-892)		Summary (PTO-413)	
<ol> <li>Notice of Draftsperson's Patent Drawing Review (PTO-948)</li> <li>Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08 Paper No(s)/Mail Date</li> </ol>		s)/Mail Date nformal Patent Application (PTO-152) 	

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### **DETAILED ACTION**

The last Office Action has a typological error, and this Office Action covers that error.

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Spitz et al. (US 6060776), hereinafter Spitz in view of Spitz et al. (US 6667545), hereinafter Spitz'545.

Regarding claim 1, Fig. 1 of Spitz shows a diode (100) comprising a connecting means (8;a wire) and a heat sink base (a region below the wire 8);

said connecting means comprising a flat end (7) fixed at a die (4) and the other end having no fixed shape;

said heat sink base comprising;

a base (2) which is on the bottom of the heat sink base;

a press-fit region (11) which is around said base (2);

a solder platform (3) which is above said base;

a die (4) which has a first side and a second side electrically coupled to said flat end (7) and said solder platform (3), respectively;

a shoulder (15) which is extended acclivitously from said solder platform, the root of said shoulder connected to said solder platform having a kink; and

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a cup (9) which is extended upwardly from the periphery of said base (2);

characterized in that said solder platform has a kink and that the combination of said acclivitous shoulder and the kink can absorbed the stress generated by the package (13) and provide a longer path for moisture to reach the die, thereby preventing moisture from reaching the die directly even if moisture enters the gap existing between the shoulder and the passivation film (14).

Fig. 1 of Spitz shows substantially the entire claimed structure except the packaging is epoxy. Fig. 1 of Spitz-645 shows an epoxy packaging (40).

It would have been obvious to one of ordinary skill in the art at the time of the invention to incorporate the teachings of Spitz'545 to the device of Spitz in order to have the package formed with epoxy since epoxy is well known and readily available packaging material.

Note that a functional recitation of "the combination of said acclivitous shoulder and the kink can absorbed the stress generated by the package and provide a longer path for moisture to reach the die, thereby preventing moisture from reaching the die directly even if moisture enters the gap existing between the shoulder and the passivation film" would not have carried patentable weight because it is narrative in form. In order to be given patentable weight, a functional recitation must be expressed as a "means" for performing the specified function, as set forth in 35 USC \$112, 6<sup>th</sup> paragraph, and must be supported by recitation in the claim of sufficient structure to warrant the presence of the functional language. *In re Fuller*, 1929 C.D. 172; 388 O.G. 279.

In addition, Spitz discloses that the combination of the acclivitous shoulder and the kink can absorb the stress generated by the package (col. 2, lines 58-62).

Regarding claim 2, Fig. 6 of Spitz-645 shows said shoulder has a height which is substantially the same as said die.

Also, note that Figures 3-5 of Spitz'535 show of a shoulder with a various height and an angle. Therefore, a variation in the height of the shoulder would have been obvious matter of an optimized design configuration since such a modification would have involved a mere change in the shape of a component. A change in shape is generally recognized as being within the level of ordinary skill in the art. In re Dailey, 357 F.2d 669, 149 USPQ 47 (CCPA 1966).

Regarding claim 3, Spitz discloses said connecting means is a lead wire (col. 3, line 22).

Regarding claim 4, Fig. 1 of Spitz shows the diode further comprises two solder layers (5a) and (5b) which sandwich said die (4) above and under, respectively.

Regarding claim 5, Fig. 1 of Spitz shows the diode further comprises passivative material (14) used to surround said wafer (4).

Regarding claim 6, Spitz'545 discloses the diode further comprises a resin (44; col. 3, line 11) for surrounding outside said passivative material (38).

Regarding claim 7, Fig. 1 of Spitz shows the diode further comprises a sheath (12) for surrounding the encapsulating material (13) inside said cup.

Regarding claim 8, Fig. 1 of Spitz shows further comprises a sheath (12) for surrounding the encapsulating material (13) outside said cup (9).

## Response to Arguments

Applicant's arguments with respect to pending claim have been considered but are moot in view of the new ground(s) of rejection.

### Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Junghwa M. Im whose telephone number is (571) 272-1655. The examiner can normally be reached on MON.-FRI. 8:30AM-5:00PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie C Lee can be reached on (571) 272-1732. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

jmi

**EDDIE LEE** 

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